

MOSFET - N-Channel, Field Effect Transistor, Enhancement Mode, Logic Level

60 V, 12 A, 0.18 Ω

MTP3055VL

General Description

This N-Channel Logic Level MOSFET has been designed specifically for low voltage, high speed switching applications i.e. power supplies and power motor controls.

This MOSFET features faster switching and lower gate charge than other MOSFETs with comparable $R_{DS(ON)}$ specifications.

The result is a MOSFET that is easy and safer to drive (even at very high frequencies).

Features

- 12 A, 60 V. $R_{DS(ON)} = 18 \Omega @ V_{GS} = 5 V$
- Critical DC Electrical Parameters Specified at Elevated Temperature
- Low Drive Requirements Allowing Operation Directly from Logic Drivers. Vgs(th) < 2 V
- Rugged Internal Source-Drain Diode Can Eliminate the Need for an External Zener Diode Transient Suppressor
- 175 °C Maximum Junction Temperature Rating
- This is a Pb-Free and Halide Free Device

MAXIMUM RATINGS (T_C = 25 °C unless otherwise noted)

Symbol	Rat	ing	Value	Unit
V _{DSS}	Drain-Source Voltage		60	٧
V _{GSS}	Drain-Source Voltage		±15	V
I _D	Drain Current	- Continuous	12	Α
		- Pulsed	42	Α
P_{D}	Power Dissipation	@ T _C = 25 °C	48	W
		Derate above 25 °C	0.32	W/°C
T _J ,T _{STG}	Operating and Storage Temperature Range	e Junction	−65 to +175	°C

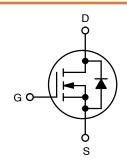
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

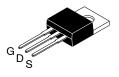
Symbol	Rating	Value	Unit
$R_{ heta JC}$	Thermal Resistance, Junction-to-Case	3.13	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1)	62.5	°C/W

^{1.} $R_{\theta \, JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance.

V _{DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	0.18 Ω @ 5 V	12 A



N-CHANNEL MOSFET



TO-220-3LD CASE 340AT

MARKING DIAGRAM

MTP 3055VL AYWWZZ

MTP3055VL = Specific Device Code
A = Assembly Location
YWW = Date Code (Year & Week)
ZZ = Assembly Lot

ORDERING INFORMATION

Device	Package	Shipping
MTP3055VL	TO-220-3LD	800 Units / Tube

MTP3055VL

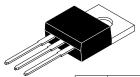
ELECTRICAL CHARACTERISTICS (T_C = 25 °C unless otherwise specified)

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Symbol	Parameter	Condition	Min	Тур	Max	Unit
DRAIN-SOL	JRCE AVALANCHE RATINGS (Note 2)					
W_{DSS}	Single Pulse Drain-Source Avalanche Energy	V _{DD} = 25 V, I _D = 12 A	-	-	72	mJ
I _{AR}	Maximum Drain-Source Avalanche Current		-	-	12	Α
OFF CHAR	ACTERISTICS					
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60	-	_	V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25 °C	-	55	-	mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 60 V, V _{GS} = 0 V	-	-	10	μΑ
		V _{DS} = 60 V, V _{GS} = 0 V, T _J = 150 °C	-	-	100	1
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = 15 V, V _{DS} = 0 V	-	-	100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = -15 V, V _{DS} = 0 V	-	-	-100	nA
ON CHARA	CTERISTICS (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	1	1.6	2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{j}}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25 °C	-	-4	-	mV/°C
R _{DS(ON})	Static Drain-Source On-Resistance	V _{GS} = 5 V, I _D = 6 A	_	0.100	0.180	Ω
V _{DS(on)}	Drain-Source On-Voltage On-Resistance	V _{GS} = 5 V, I _D = 12 A	-	-	2.6	V
9 _{FS}	Forward Transconductance	V _{DS} = 8 V, I _D = 6 A	5	8.7	_	S
DYNAMIC C	CHARACTERISTICS	•	•	•	•	•
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V,	_	345	570	pF
C _{oss}	Output Capacitance	f = 1.0 MHz	_	110	160	pF
C _{rss}	Reverse Transfer Capacitance		_	30	40	pF
SWITCHING	G CHARACTERISTICS (Note 2)	•				
t _{D(on)}	Turn-On Delay Time	V_{DD} = 30 V, I_{D} = 12 A, V_{GS} = 5 V, R_{GEN} = 9.1 Ω	-	_	20	ns
t _r	Turn-On Rise Time		_	-	190	ns
t _{D(off)}	Turn-Off Delay Time		_	-	30	ns
tf	Turn-Off Fall Time		_	-	90	ns
Qq	Total Gate Charge	V _{DS} = 48 V, I _D = 12 A,	-	7.8	10	nC
Q _{gs}	Gate-Source Charge	V _{GS} = 5 V	_	1.7	-	nC
Q _{gd}	Gate-Drain Charge	1	_	3.2	-	nC
	JRCE DIODE CHARACTERISTICS AND MAXIM	NUM RATINGS	-	-	-	-
I _S	Maximum Continuous Drain-Source Diode Forward Current (Note 2)		-	-	12	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward	Current (Note 2)	-	-	42	Α
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = 12 A (Note 2)	-	-	1.3	V
		•				

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

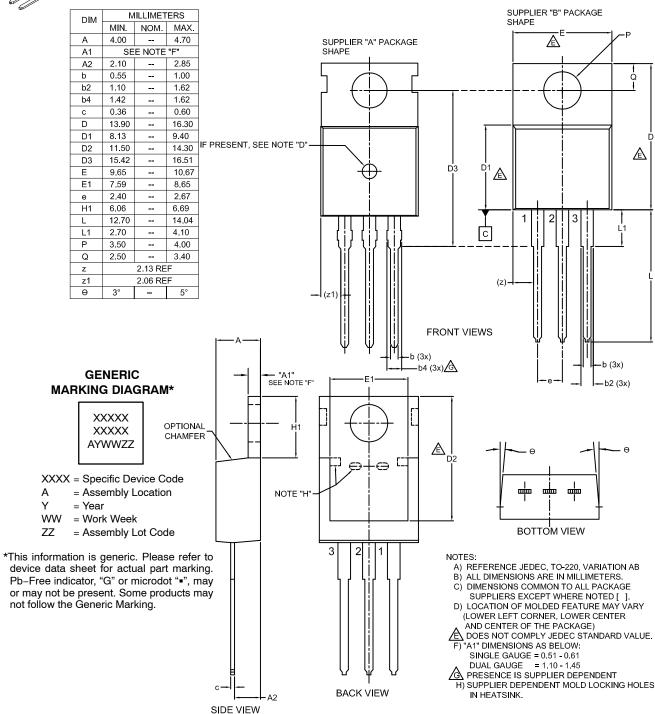
2. Pulse Test: pulse width $\leq 300 \ \mu s$, duty cycle $\leq 2.0\%$.





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